

A700-M

Fingerprint Module

- ✓ FBI Certified: PIV Specification, Mobile ID FAP 30
- ✓ Live Finger Detection (LFD)



Aratek A700-M is certified by the FBI as FIPS 201/PIV 071006 and Mobile ID FAP 30 compliant fingerprint module. The larger sensing area $(20.32 \times 25.4 \text{ mm})$ enables it to cover a much bigger surface area and capture more biometric data from fingerprints. A700-M also comes with Live Finger Detection (LFD) technology, making it a perfect solution for applications that require an even higher standard of accuracy and security.

Features

FBI Certified

FIPS 201/PIV 071006, FBI Mobile ID FAP 30

International Standards

 $\hspace{1.5cm} \hspace{1.5cm} \hspace{1.5cm}$

• Live Finger Detection (LFD)

LFD rejects spoofing attempts by screening the liveness of the finger being captured

Advanced Algorithm

NIST MINEX III compliance Bione® fingerprint algorithm delivers the highest extracting and matching performance

AES-256 Encryption

256-bit AES encryption (AES-256) to ensure the security of your fingerprint data in transit

Strong Adaption

Good adaption for dry, moist and rough fingerprints

Correction and Authentication

Supports auto correction and 360 degree rotation authentication

Cloud Platform

Seamlessly join in Aratek TrustLinkTM biometrics authentication platform

Different OS Support

Windows 2000, XP, Vista, Windows 7/8/10, Android and other embedded systems

Comprehensive SDK

Comprehensive software development kit is available for development and integration

A Wide Range of Interfaces

Supports UART, SPI and USB interfaces for easy integration

Applications

- PC/NetworkSecurity
- Hospitality
- Finance and Banking

- Telecommunication
- Healthcare
- Law Enforcement

A700-M Fingerprint Module

Physical Parameter

Performance Parameter

Sensor Type	Optical
Platen Size (W*L)	21.0*26.0 mm
Sensing Area (W*L)	20.32*25.4 mm
Fingerprint Image Size	400*500 pixels
Image Resolution	500 dpi
Gray level	8 bits, 256 level

Communication Mode

Communication Interface	UART (TTL 115200bps default) USB 1.1 / 2.0
	SPI (Slave 3.3V)

Operation Environment

Work Voltage	5.0 V (USB)
Work Current	150 mA
Operating Temperature	-10°C~55°C
Operating Humidity	10~93%R.H
ESD	Contact: ±8KV, Air: ±15KV

Certification

FCC, CE, RoHS, FBI-PIV FAP 30

Supported OS

Windows, Android, Linux, Embedded systems

